

NCX2200

Low voltage comparator

Rev. 5 — 6 August 2012

Product data sheet

1. General description

The NCX2200 provides a single low voltage, low power, comparator.

The NCX2200 has a very low supply current of 6 μA and is guaranteed to operate at a low voltage of 1.3 V and is fully operational up to 5.5 V. These characteristics make the device convenient for use in both 3.0 V and 5.0 V systems.

2. Features and benefits

- Wide supply voltage range from 1.3 V to 5.5 V (functional operating range)
- Rail-to-rail input/output performance
- Very low supply current of 6 μA (typical)
- Very low-power consumption
- No phase inversion with overdriven input signals
- Internal hysteresis
- Propagation delay of 0.8 μs (typical)
- ESD protection:
 - ◆ HBM JESD22-A114F Class 3A. Exceeds 2000 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$

3. Applications

- Cellular telephones
- Alarm and security systems
- Personal Digital assistants



4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
NCX2200GW	−40 °C to +85 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
NCX2200GM	−40 °C to +85 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
NCX2200GF3	−40 °C to +85 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm	SOT891

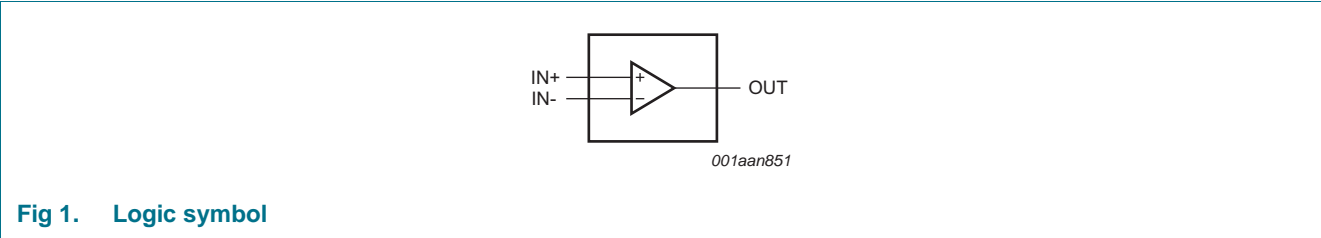
5. Marking

Table 2. Marking codes

Type number	Marking ^[1]
NCX2200GM	q1
NCX2200GW	q1
NCX2200GF3	q3

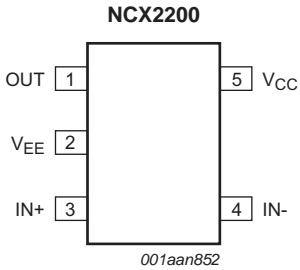
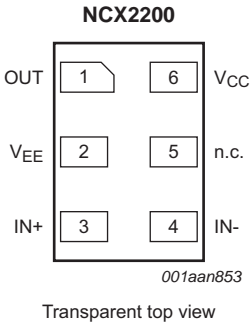
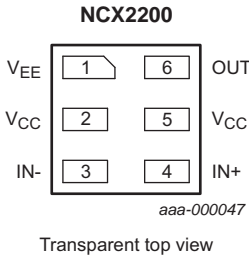
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram



7. Pinning information

7.1 Pinning

 <p>Fig 2. Pin configuration SOT353-1</p>	 <p>Fig 3. Pin configuration SOT886</p>	 <p>Fig 4. Pin configuration SOT891</p>
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7.2 Pin description

Table 3. Pin description

Symbol	Pin			Description
	SOT353-1	SOT886	SOT891	
OUT	1	1	6	comparator output
V_{EE}	2	2	1	supply voltage
IN+	3	3	4	comparator input (positive)
IN–	4	4	3	comparator input (negative)
n.c.	-	5	-	not connected
V_{CC}	5	6	2, 5	supply voltage

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to V_{EE} .

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-	7.0	V
V_I	input voltage	IN–, IN+ inputs	–0.5	$V_{CC} + 0.5$	V
$t_{sc(o)}$	output short-circuit time		[1] -	indefinite	s
$T_{j(max)}$	maximum junction temperature		-	+150	°C
T_{stg}	storage temperature		–65	+150	°C
P_{tot}	total power dissipation	$T_{amb} = -40\text{ °C to }+85\text{ °C}$	-	250	mW

[1] The maximum total power dissipation must not be exceeded.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{CC}	supply voltage	V_{CC} to V_{EE}				
		full spec operating range	1.6	-	5.5	V
		functional operating range	1.3	-	5.5	V
V_I	input voltage		V_{EE}	-	V_{CC}	V
T_{amb}	ambient temperature		-40	-	+85	°C

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. $V_{CC} = 1.6\text{ V}$ to 5.5 V , $V_{EE} = 0\text{ V}$; $V_{CM} = 0.5V_{CC}$ unless otherwise specified.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		Unit
			Min	Typ	Max	Min	Max	
V_H	hysteresis voltage		6	9	13	-	-	mV
		$V_{CC} = 1.3\text{ V}$	-	20	-	-	-	mV
$V_{I(\text{offset})}$	offset input voltage	[1] $V_{CC} = 1.3\text{ V}$	-30	0.5	+30	-30	+30	mV
		[1] $V_{CC} = 1.3\text{ V}$	-	3	-	-	-	mV
V_{OH}	HIGH-level output voltage	$I_O = -0.5\text{ mA}$; $V_{CC} = 1.3\text{ V}$	-	1.24	-	-	-	V
		$I_O = -0.5\text{ mA}$; $V_{CC} = 1.6\text{ V}$	-	1.55	-	1.35	-	V
		$I_O = -3\text{ mA}$; $V_{CC} = 3.0\text{ V}$	-	2.85	-	2.7	-	V
		$I_O = -5\text{ mA}$; $V_{CC} = 5.5\text{ V}$	-	5.33	-	5.2	-	V
V_{OL}	LOW-level output voltage	$I_O = 0.5\text{ mA}$; $V_{CC} = 1.3\text{ V}$	-	0.05	-	-	-	V
		$I_O = 0.5\text{ mA}$; $V_{CC} = 1.6\text{ V}$	-	0.04	-	-	0.25	V
		$I_O = 3\text{ mA}$; $V_{CC} = 3.0\text{ V}$	-	0.14	-	-	0.3	V
		$I_O = 5\text{ mA}$; $V_{CC} = 5.5\text{ V}$	-	0.20	-	-	0.3	V
V_{CM}	common-mode voltage	$V_{CC} = 1.3\text{ V}$ to 5.5 V	-	V_{EE} to V_{CC}	-	-	-	V
I_{OS}	output short-circuit current	$V_{CC} = 5.5\text{ V}$; $V_O = V_{EE}$ or V_{CC}	-	68	-	-	-	mA
CMRR	common-mode rejection ratio	$\Delta V_{CM} = V_{CC}$	-	70	-	-	-	dB
PSRR	power supply rejection ratio	$\Delta V_{CC} = 1.95\text{ V}$	45	80	-	-	-	dB
I_{IB}	input bias current		-	1.0	-	-	-	pA
I_{CC}	supply current		-	6.0	-	-	9.0	μA

[1] Differential input switching level is guaranteed at the minimum or maximum offset voltage, minus or plus half the maximum hysteresis voltage.

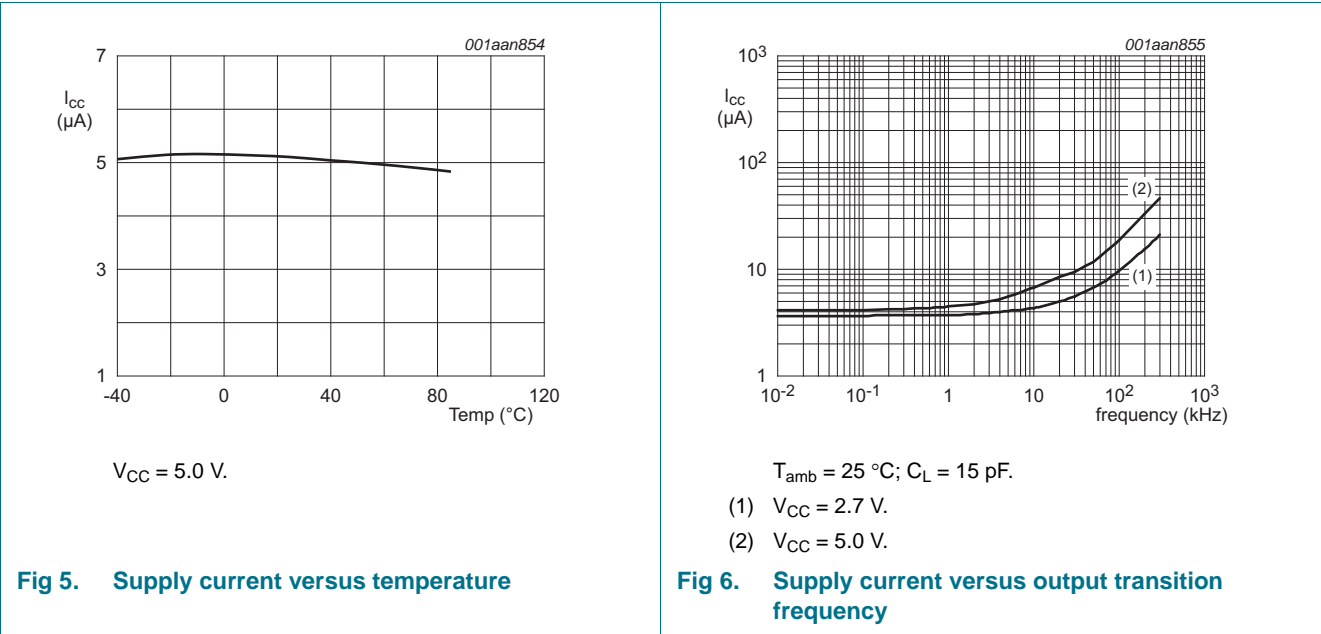
11. Dynamic characteristics

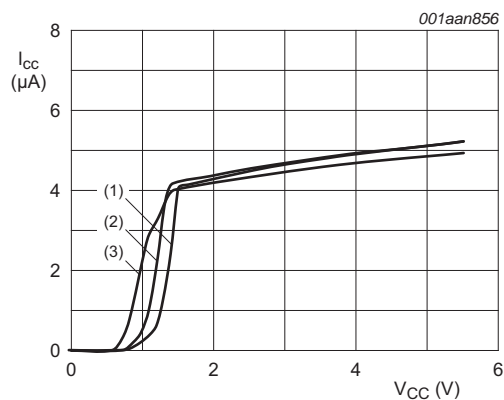
Table 7. Dynamic characteristics
Voltages are referenced to V_{EE} ($V_{EE} = 0\text{ V}$); $V_{CC} = 1.6\text{ V to }5.5\text{ V}$; $V_{CM} = 0.5V_{CC}$ unless otherwise specified.

Symbol	Parameter	Conditions	25 °C			Unit	
			Min	Typ	Max		
t_{pd}	propagation delay	20 mV overdrive; $C_L = 15\text{ pF}$	[1]	-	0.8	-	μs
t_{THL}	HIGH to LOW output transition time	$V_{CC} = 5.5\text{ V}$; $C_L = 50\text{ pF}$	[2]	-	10	-	ns
t_{TLH}	LOW to HIGH output transition time	$V_{CC} = 5.5\text{ V}$; $C_L = 50\text{ pF}$	[2]	-	10	-	ns

- [1] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [2] Input signal: 1 kHz, square wave signal with 10 ns edge rate.

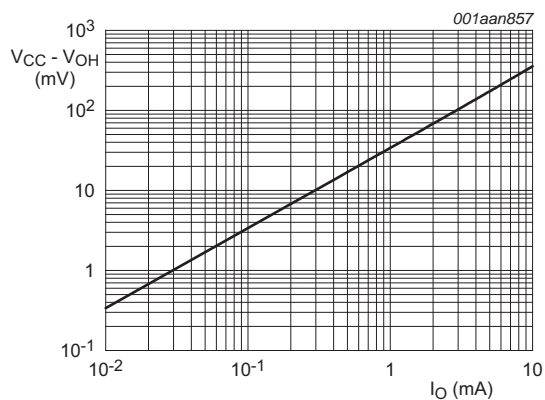
12. Graphs





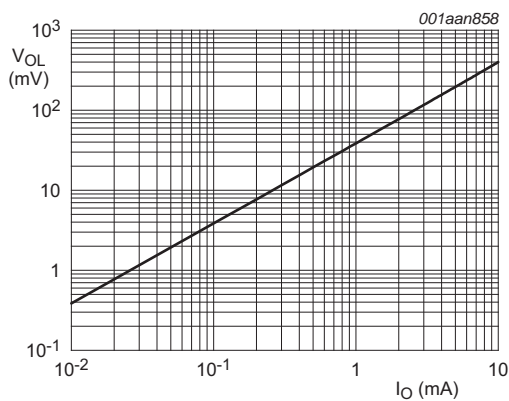
- (1) $T_{amb} = -40\text{ }^{\circ}C$.
- (2) $T_{amb} = 25\text{ }^{\circ}C$.
- (3) $T_{amb} = 85\text{ }^{\circ}C$.

Fig 7. Supply current versus supply voltage



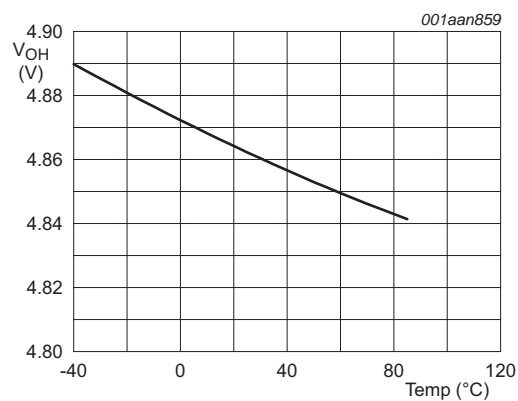
$T_{amb} = 25\text{ }^{\circ}C$.
 $V_{CC} = 5.0\text{ V}$.

Fig 8. HIGH-level output voltage versus output current



$T_{amb} = 25\text{ }^{\circ}C$.
 $V_{CC} = 5.0\text{ V}$.

Fig 9. LOW-level output voltage versus output current



$I_O = -4.0\text{ mA}$.
 $V_{CC} = 5.0\text{ V}$.

Fig 10. HIGH-level output voltage versus temperature

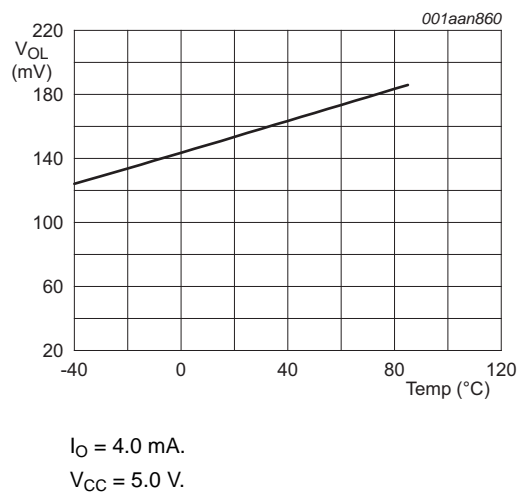


Fig 11. LOW-level output voltage versus temperature

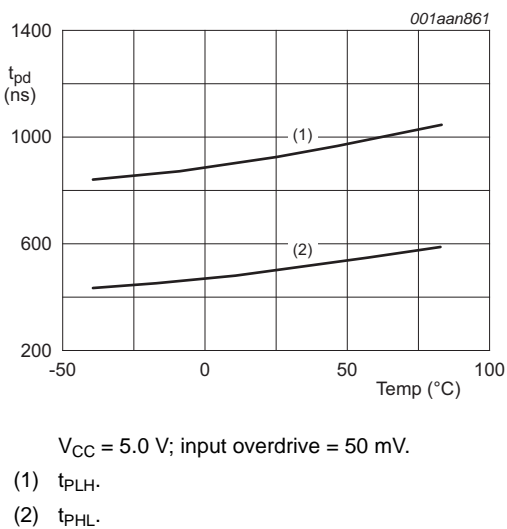


Fig 12. Propagation delay versus temperature

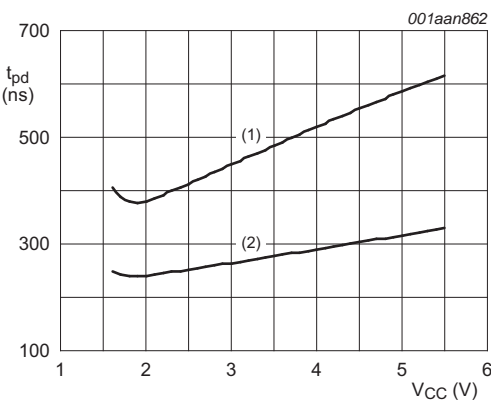


Fig 13. Propagation delay versus supply voltage.

13. Application information

13.1 Operating description

The NCX2200 is a single low voltage, low power, comparator. This device is designed for rail-to-rail input and output performance. This device consumes only 6 μA of supply current while achieving a typical propagation delay of 0.8 μs at a 20 mV input overdrive. This comparator is guaranteed to operate at a low voltage of 1.3 V up to 5.5 V. The common-mode input voltage range extends 0.1 V beyond the upper and lower rail without phase inversion or other adverse effects. This device has a typical internal hysteresis of 9.0 mV. This allows for greater noise immunity and clean output switching.

13.2 Output stage

The NCX2200 has a complementary P and N Channel output stage that has capability of driving a rail-to-rail output swing with a load ranging up to 5.0 mA. It is designed such that shoot-through current is minimized while switching. This feature eliminates the need for bypass capacitors under most circumstances. See [Figure 14](#)

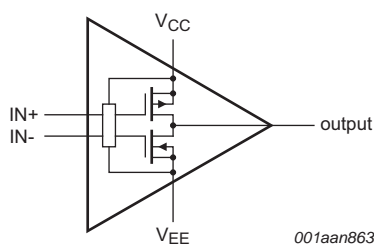
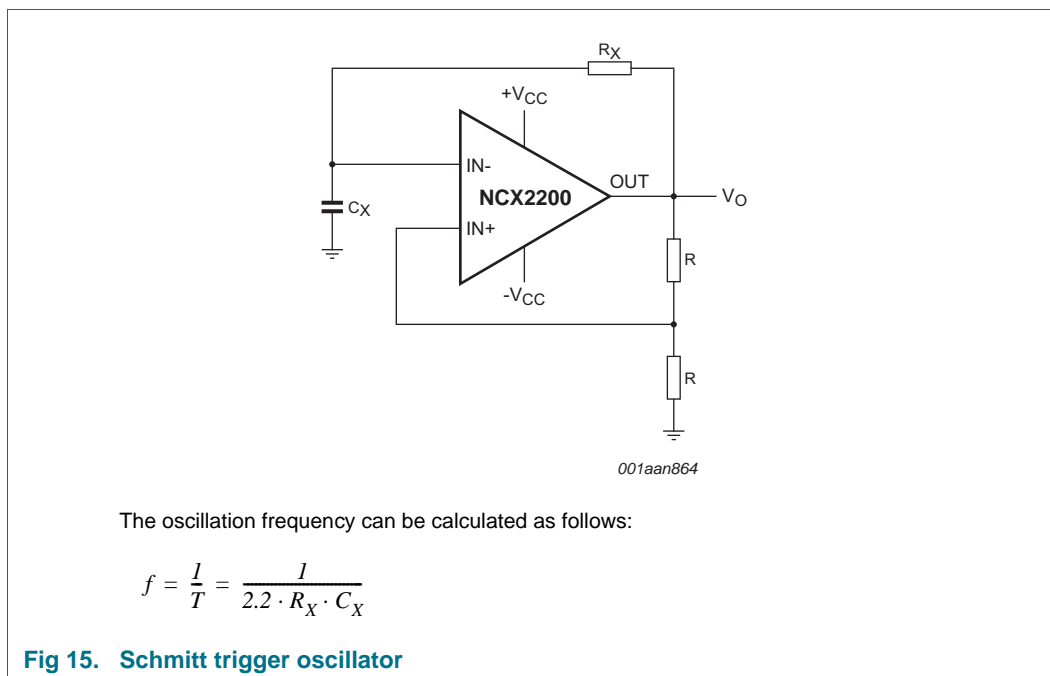


Fig 14. NCX2200 complementary output configuration

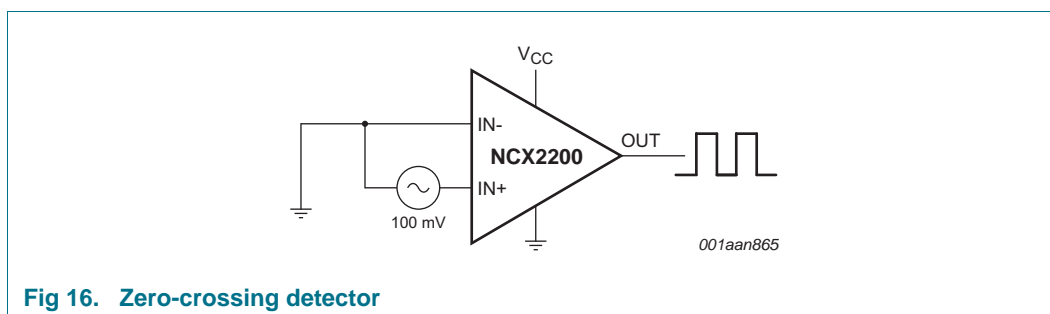
13.3 Schmitt trigger oscillator

Figure 15 shows the NCX2200 configured as a Schmitt trigger oscillator.



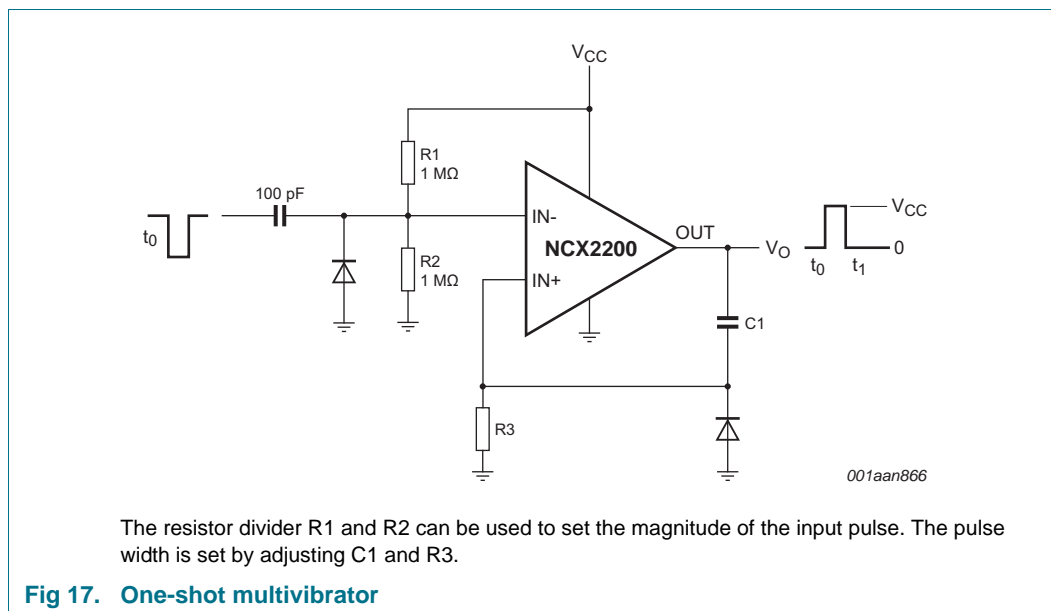
13.4 Zero-crossing detector

Figure 16 shows the NCX2200 configured as a zero-crossing detector.



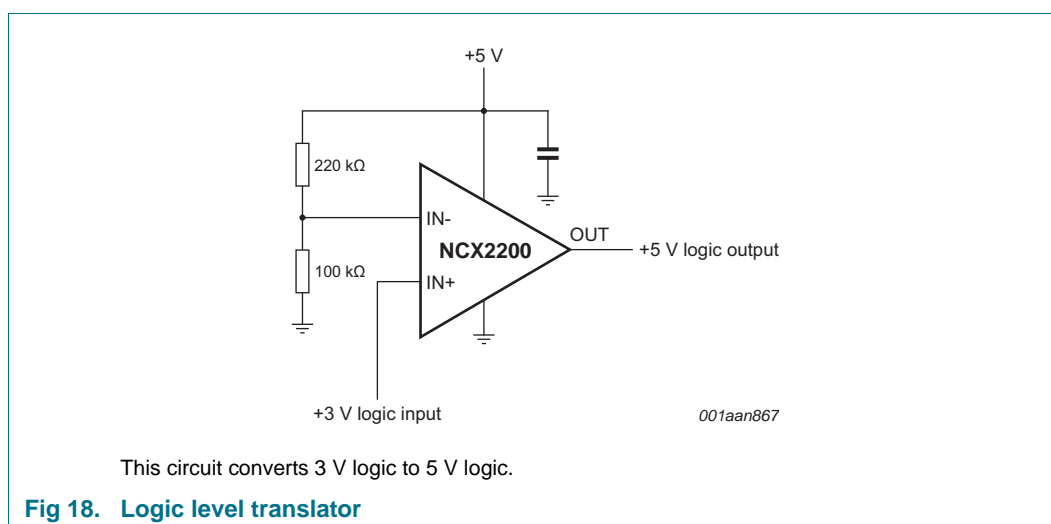
13.5 One-shot multivibrator

Figure 17 shows the NCX2200 configured as a one-shot multivibrator.



13.6 Logic level translator

Figure 18 shows the NCX2200 configured as a logic level translator.



14. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1

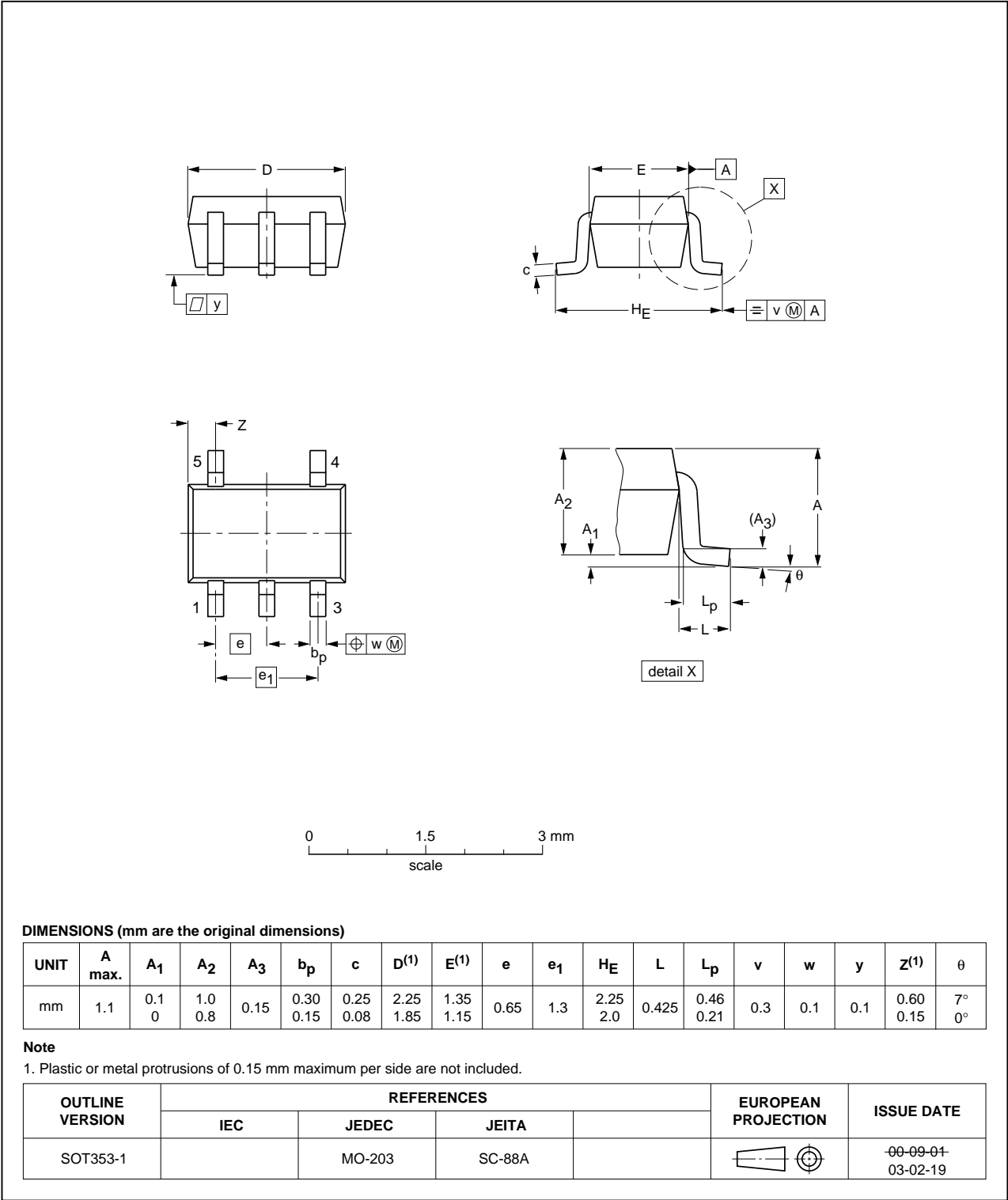


Fig 19. Package outline SOT353-1 (TSSOP5)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

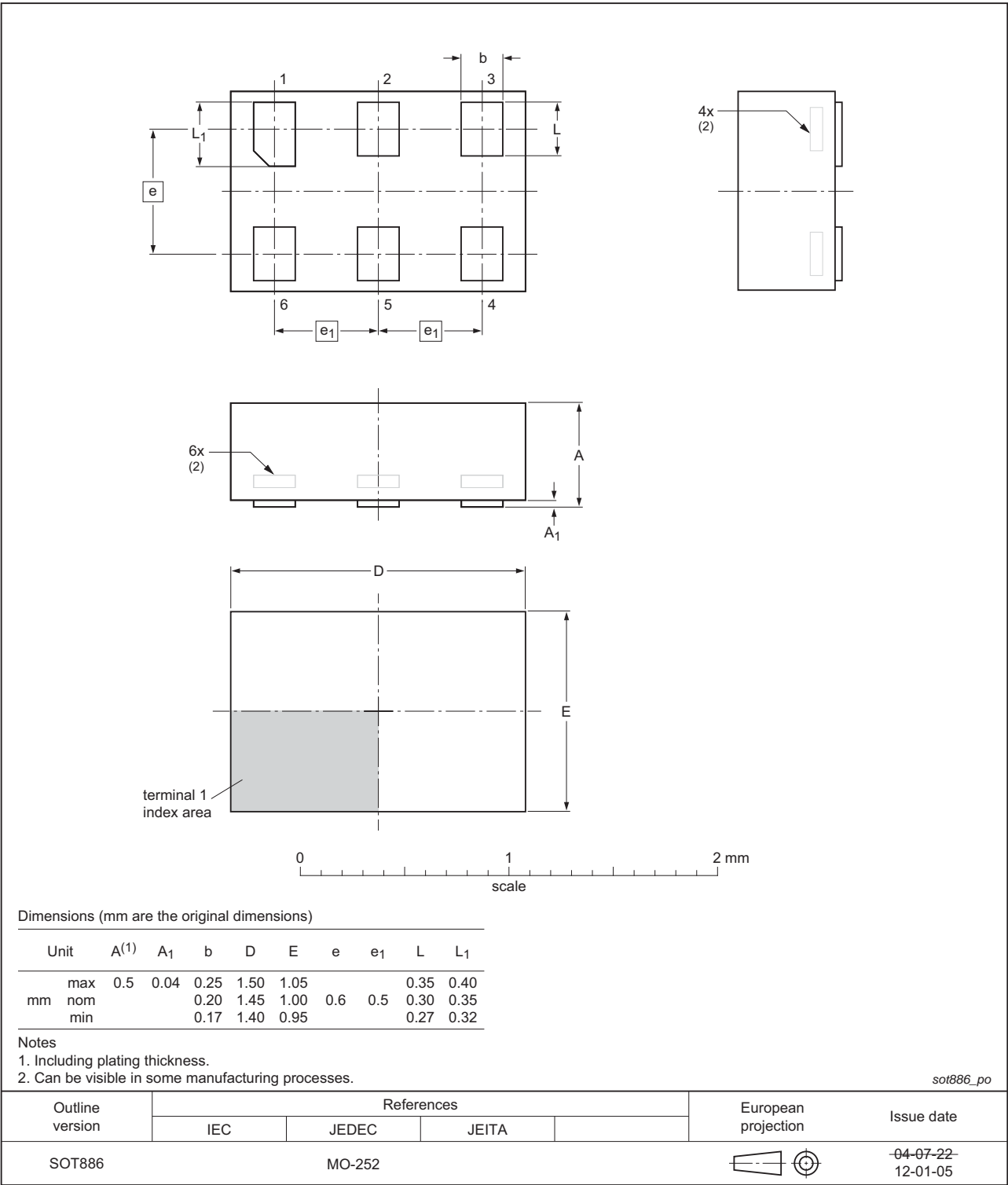


Fig 20. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

SOT891

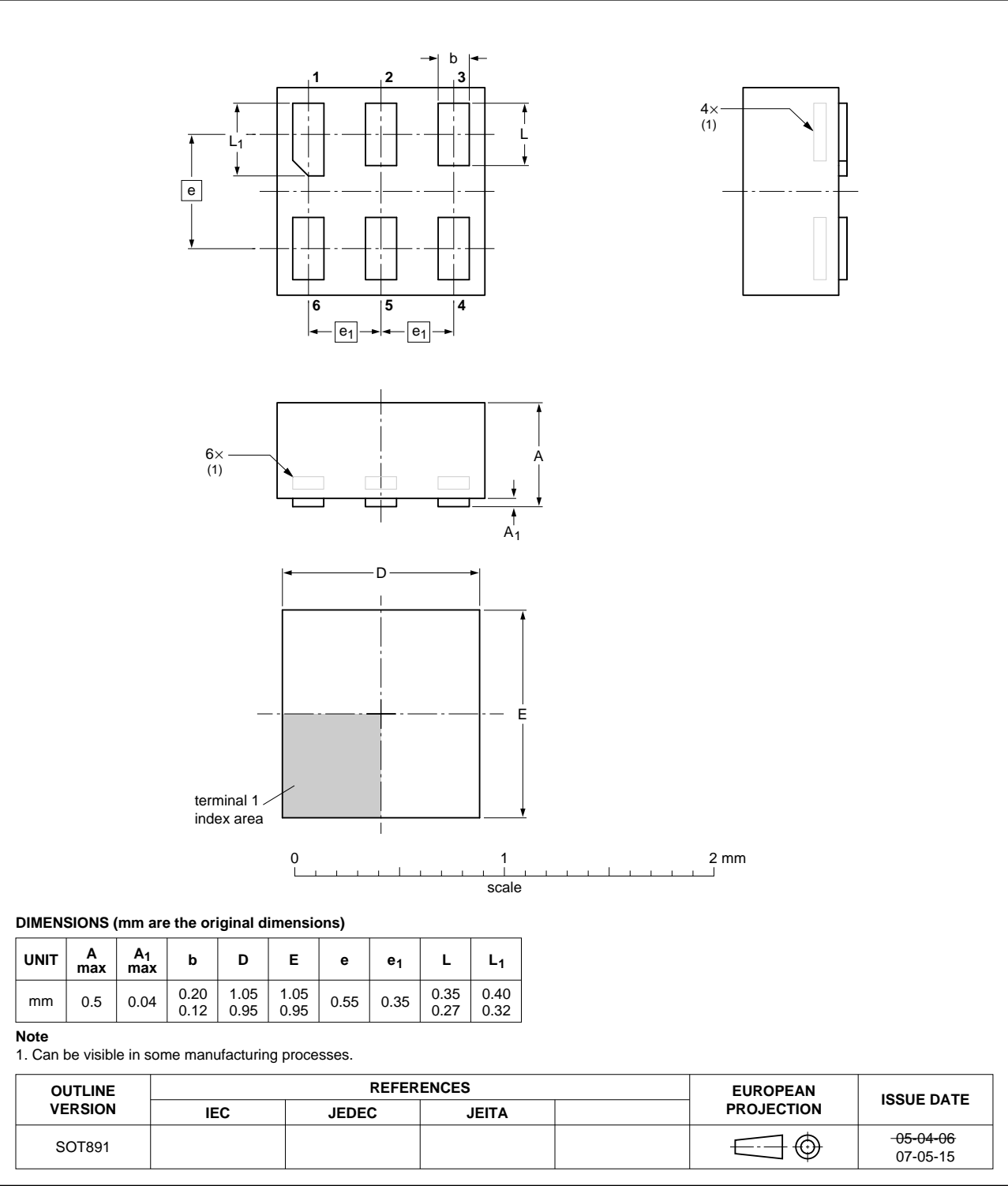


Fig 21. Package outline SOT891 (XSON6)

15. Abbreviations

Table 8. Abbreviations

Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
HBM	Human Body Model

16. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NCX2200 v5	20120806	Product data sheet	-	NCX2200 v.4
Modifications:	• Package outline drawing of SOT886 (Figure 20) modified.			
NCX2200 v4	20111110	Product data sheet	-	NCX2200 v.3
Modifications:	• Legal pages updated.			
NCX2200 v.3	20111014	Product data sheet	-	NCX2200 v.2
NCX2200 v.2	20110706	Product data sheet	-	NCX2200 v.1
NCX2200 v.1	20110322	Product data sheet	-	-

17. Legal information

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Document status ^{[1][2]}	Product status ^[3]	Definition
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Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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